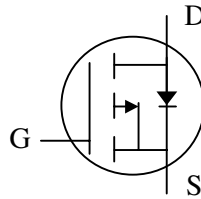




P-channel Enhancement-mode Power MOSFET

- Simple Gate Drive
- Small Package Outline
- Low Gate Charge
- RoHS-compliant, halogen-free



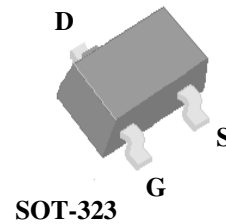
BV_{DSS}	-20V
$R_{DS(ON)}$	800mΩ
I_D	-550mA

Description

Advanced Power MOSFETs from APEC provide the designer with the best combination of fast switching, low on-resistance and cost-effectiveness.

The AP1333GU-HF-3 is in the popular SOT-323 small surface-mount package which is widely used in commercial and industrial applications where a small board footprint is required.

This device is well suited for use in applications such as load switches.



Absolute Maximum Ratings

Symbol	Parameter	Rating	Units
V_{DS}	Drain-Source Voltage	-20	V
V_{GS}	Gate-Source Voltage	±12	V
I_D at $T_A=25^\circ\text{C}$	Continuous Drain Current ³	-0.55	A
I_D at $T_A=70^\circ\text{C}$	Continuous Drain Current ³	-0.44	A
I_{DM}	Pulsed Drain Current ¹	-2.5	A
P_D at $T_A=25^\circ\text{C}$	Total Power Dissipation	0.35	W
T_{STG}	Storage Temperature Range	-55 to 150	°C
T_J	Operating Junction Temperature Range	-55 to 150	°C

Thermal Data

Symbol	Parameter	Value	Unit
Rthj-a	Maximum Thermal Resistance, Junction-ambient ³	360	°C/W

Ordering Information

AP1333GU-HF-3TR RoHS-compliant halogen-free SOT-323, shipped on tape and reel, 3000pcs/reel



Electrical Specifications at $T_j=25^\circ\text{C}$ (unless otherwise specified)

Symbol	Parameter	Test Conditions	Min.	Typ.	Max.	Unit
BV_{DSS}	Drain-Source Breakdown Voltage	$V_{GS}=0V, I_D=-250\mu A$	-20	-	-	V
$\Delta BV_{DSS}/\Delta T_j$	Breakdown Voltage Temperature Coefficient	Reference to 25°C , $I_D=-1\text{mA}$	-	-0.01	-	V/ $^\circ\text{C}$
$R_{DS(ON)}$	Static Drain-Source On-Resistance	$V_{GS}=-10V, I_D=-550\text{mA}$	-	-	600	m Ω
		$V_{GS}=-4.5V, I_D=-500\text{mA}$	-	-	800	m Ω
		$V_{GS}=-2.5V, I_D=-300\text{mA}$	-	-	1000	m Ω
$V_{GS(th)}$	Gate Threshold Voltage	$V_{DS}=V_{GS}, I_D=-250\mu A$	-0.5	-	-1.2	V
g_{fs}	Forward Transconductance	$V_{DS}=-5V, I_D=-500\text{mA}$	-	1	-	S
I_{DSS}	Drain-Source Leakage Current ($T_j=25^\circ\text{C}$)	$V_{DS}=-20V, V_{GS}=0V$	-	-	-1	μA
	Drain-Source Leakage Current ($T_j=70^\circ\text{C}$)	$V_{DS}=-16V, V_{GS}=0V$	-	-	-10	μA
I_{GSS}	Gate-Source Leakage	$V_{GS}=\pm 12V$	-	-	± 100	nA
Q_g	Total Gate Charge ²	$I_D=-500\text{mA}$	-	1.7	2.7	nC
Q_{gs}	Gate-Source Charge	$V_{DS}=-16V$	-	0.3	-	nC
Q_{gd}	Gate-Drain ("Miller") Charge	$V_{GS}=-4.5V$	-	0.4	-	nC
$t_{d(on)}$	Turn-on Delay Time ²	$V_{DS}=-10V$	-	5	-	ns
t_r	Rise Time	$I_D=-500\text{mA}$	-	8	-	ns
$t_{d(off)}$	Turn-off Delay Time	$R_G=3.3\Omega, V_{GS}=-5V$	-	10	-	ns
t_f	Fall Time	$R_D=20\Omega$	-	2	-	ns
C_{iss}	Input Capacitance	$V_{GS}=0V$	-	66	105.6	pF
C_{oss}	Output Capacitance	$V_{DS}=-10V$	-	25	-	pF
C_{rss}	Reverse Transfer Capacitance	$f=1.0\text{MHz}$	-	20	-	pF

Source-Drain Diode

Symbol	Parameter	Test Conditions	Min.	Typ.	Max.	Unit
V_{SD}	Forward On Voltage ²	$I_S=-300\text{mA}, V_{GS}=0V$	-	-	-1.2	V

Notes:

1. Pulse width limited by maximum junction temperature.
2. Pulse test - pulse width $\leq 300\mu s$, duty cycle $\leq 2\%$
3. Surface mounted on FR4 board, $t \leq 10$ sec.

THIS PRODUCT IS SENSITIVE TO ELECTROSTATIC DISCHARGE, PLEASE HANDLE WITH CAUTION.

USE OF THIS PRODUCT AS A CRITICAL COMPONENT IN LIFE SUPPORT OR OTHER SIMILAR SYSTEMS IS NOT AUTHORIZED.

APEC DOES NOT ASSUME ANY LIABILITY ARISING OUT OF THE APPLICATION OR USE OF ANY PRODUCT OR CIRCUIT DESCRIBED HEREIN; NEITHER DOES IT CONVEY ANY LICENSE UNDER ITS PATENT RIGHTS, NOR THE RIGHTS OF OTHERS.

APEC RESERVES THE RIGHT TO MAKE CHANGES WITHOUT FURTHER NOTICE TO ANY PRODUCTS HEREIN TO IMPROVE RELIABILITY, FUNCTION OR DESIGN.



Typical Electrical Characteristics

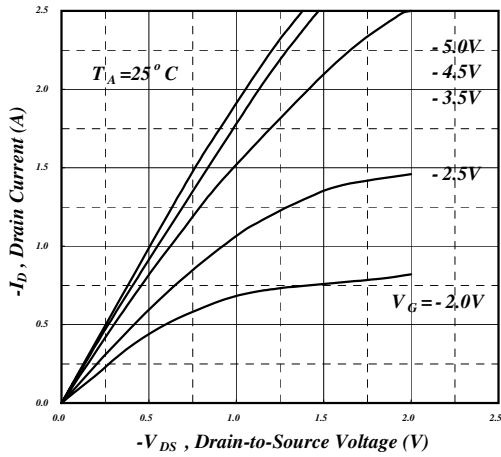


Fig 1. Typical Output Characteristics

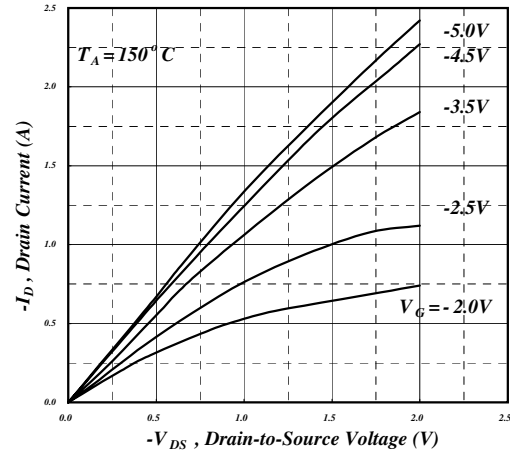


Fig 2. Typical Output Characteristics

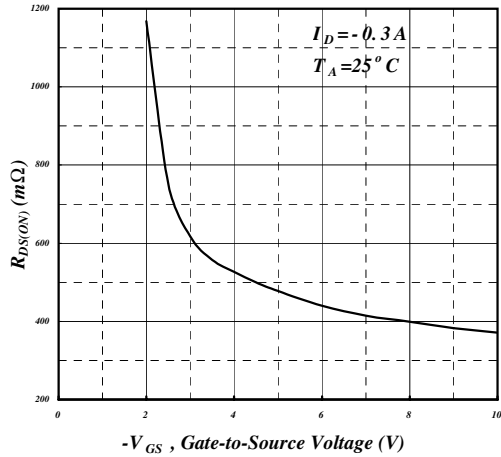


Fig 3. On-Resistance vs. Gate Voltage

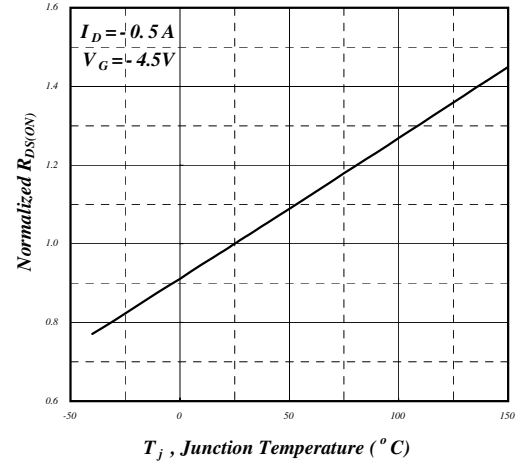


Fig 4. Normalized On-Resistance vs. Junction Temperature

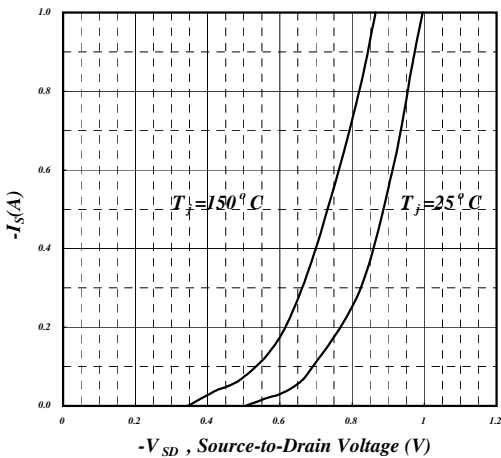


Fig 5. Forward Characteristic of Reverse Diode

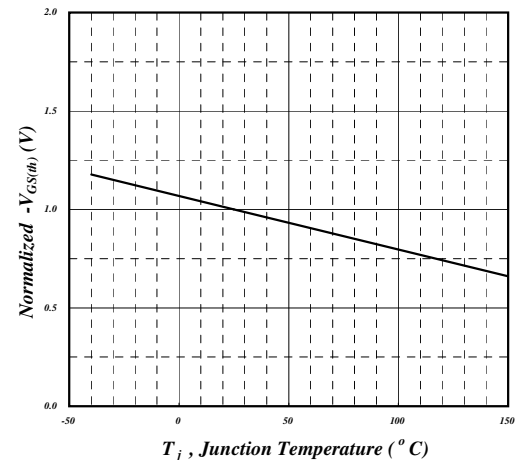


Fig 6. Gate Threshold Voltage vs. Junction Temperature



Typical Electrical Characteristics (cont.)

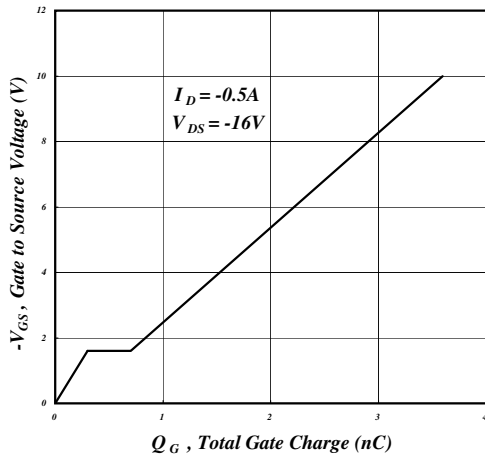


Fig 7. Gate Charge Characteristics

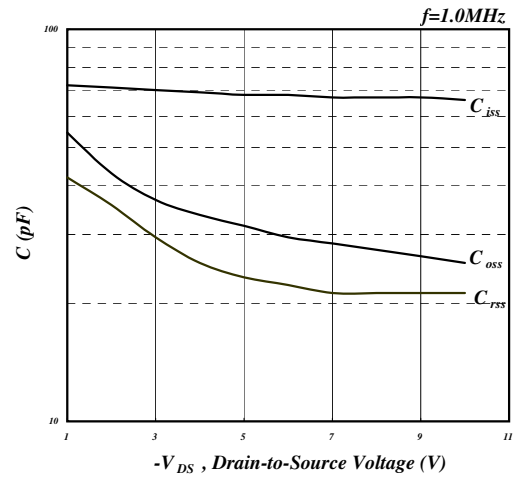


Fig 8. Typical Capacitance Characteristics

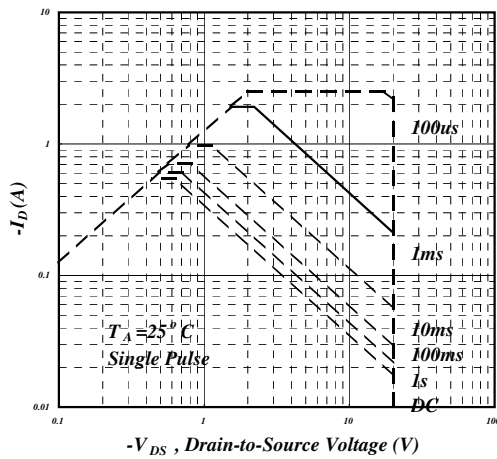


Fig 9. Maximum Safe Operating Area

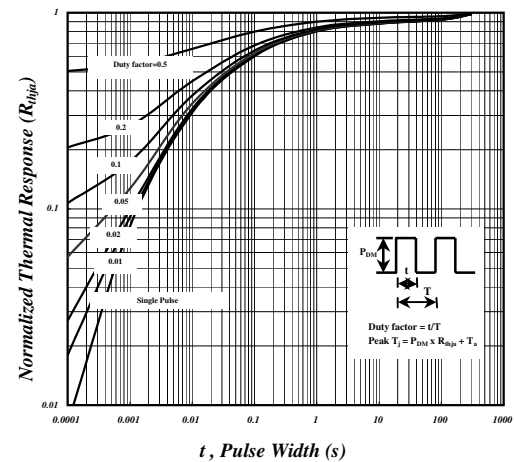


Fig 10. Effective Transient Thermal Impedance

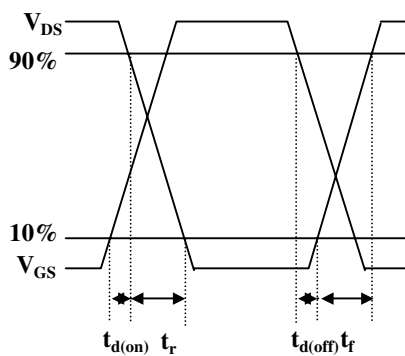


Fig 11. Switching Time Waveform

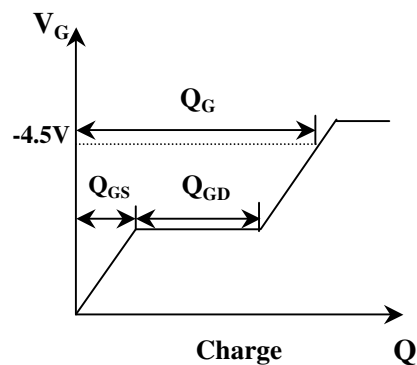
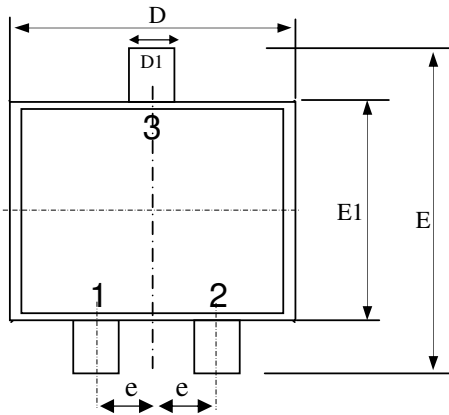


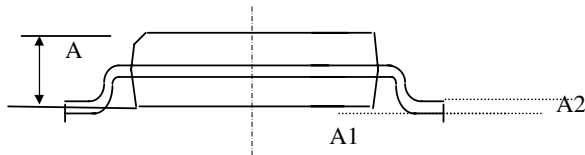
Fig 12. Gate Charge Waveform



Package Dimensions: SOT-323

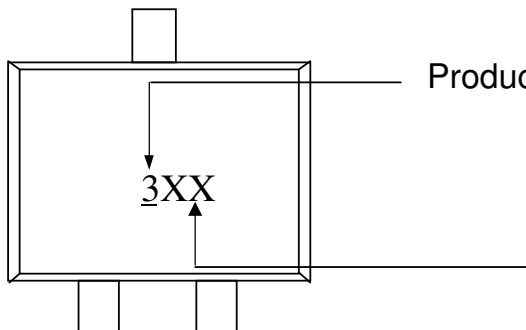


SYMBOLS	Millimeters		
	MIN	NOM	MAX
A	0.80	0.90	1.00
A1	0.00	0.05	0.10
A2		0.15	
D1	0.25	0.33	0.40
e		0.65	
D	1.80	2.00	2.20
E	1.80	2.10	2.40
E1	1.15	1.25	1.35



1. All Dimensions are in millimeters.
2. Dimensions do not include mold protrusions.

Marking Information: SOT-323



Date/lot code

For details of how to convert this to standard YYWW date code format, please contact us directly.